

RoHS

HALOGEN FREE

GREEN

High Speed Infrared Emitting Diodes, 940 nm, GaAlAs, MQW



DESCRIPTION

VSMB2948 series are infrared, 940 nm emitting diodes in GaAlAs multi quantum well (MQW) technology with high radiant power and high speed, molded in clear, untinted plastic packages (with lens) for surface mounting (SMD).

APPLICATIONS

- IR touch panels
- · Remote control

FEATURES

Package type: surface mount

• Package form: GW, RGW



Peak wavelength: λ_p = 940 nm

High reliability

• High radiant power

High radiant intensity

• Angle of half intensity: $\varphi = \pm 25^{\circ}$

· Low forward voltage

· Suitable for high pulse current operation

· Terminal configurations: gullwing or reserve gullwing

 Package matches with detector VEMD2xx3X01 and VEMT2xx3X01 series

• Floor life: 4 weeks, MSL 2a, acc. J-STD-020

 Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

PRODUCT SUMMARY				
COMPONENT	I _e (mW/sr)	φ (deg)	λ _p (nm)	t _r (ns)
VSMB2948RG	20	± 25	940	15
VSMB2948G	20	± 25	940	15

Note

• Test conditions see table "Basic Characteristics"

ORDERING INFORMATION					
ORDERING CODE PACKAGING		REMARKS	PACKAGE FORM		
VSMB2948RG	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Reverse gullwing		
VSMB2948G	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Gullwing		

Note

· MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage		V_R	5	V	
Forward current		I _F	100	mA	
Surge forward current	t _p = 100 μs	I _{FSM}	500	mA	
Power dissipation		P_V	160	mW	
Junction temperature		Tj	100	°C	
Operating temperature range		T _{amb}	- 40 to + 85	°C	
Storage temperature range		T _{stg}	- 40 to + 100	°C	
Soldering temperature	according figure 9, J-STD-020	T _{sd}	260	°C	
Thermal resistance junction/ambient J-STD-051, leads 7 mm, soldered on PCB		R _{thJA}	250	K/W	

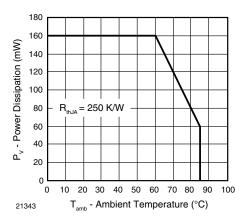


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

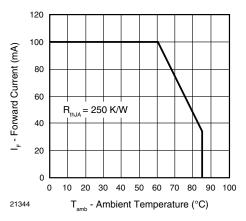


Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	V _F	1.15	1.35	1.6	V
Forward voltage	$I_F = 500 \text{ mA}, t_p = 100 \mu \text{s}$	V_{F}		1.8		V
Temperature coefficient of V _F	I _F = 1 mA	TK _{VF}		- 1.5		mV/K
Reverse current	V _R = 5 V	I _R			10	μA
Junction capacitance	$V_R = 0 \text{ V}, f = 1 \text{ MHz}, E = 0 \text{ mW/cm}^2$	CJ		21		pF
Dadient intensity	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	l _e	10	20	30	mW/sr
Radiant intensity	$I_F = 500 \text{ mA}, t_p = 100 \mu \text{s}$	l _e		90		mW/sr
Radiant power	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	φ _e		40		mW
Temperature coefficient of radiant power	I _F = 1 mA	TKφ _e		- 1.1		%/K
Angle of half intensity		φ		± 25		deg
Peak wavelength	I _F = 30 mA	λ_{p}	920	940	960	nm
Spectral bandwidth	I _F = 30 mA	Δλ		25		nm
Temperature coefficient of λ_p	I _F = 30 mA	TKλ _p		0.25		nm/K
Rise time	I _F = 100 mA, 20 % to 80 %	t _r		15		ns
Fall time	I _F = 100 mA, 20 % to 80 %	t _f		15		ns
Cut-off frequency	$I_{DC} = 70 \text{ mA}, I_{AC} = 30 \text{ mA pp}$	f _c		23		MHz

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

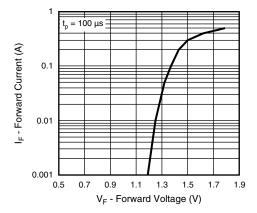


Fig. 3 - Forward Current vs. Forward Voltage

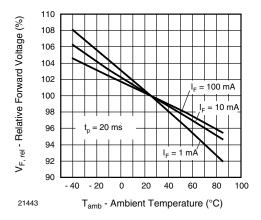


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

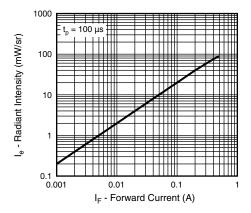


Fig. 5 - Radiant Intensity vs. Forward Current

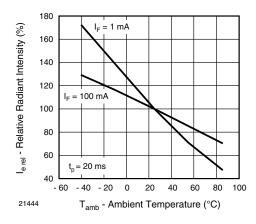


Fig. 6 - Relative Radiant Intensity vs. Ambient Temperature

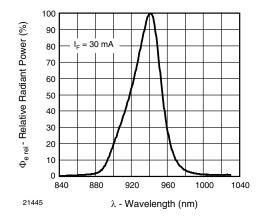


Fig. 7 - Relative Radiant Power vs. Wavelength

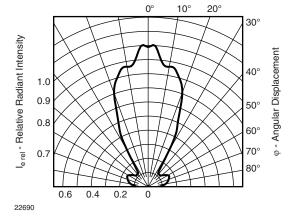


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement

SOLDER PROFILE

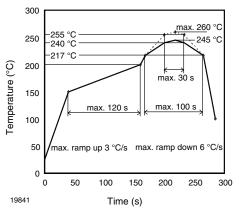


Fig. 9 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 4 weeks

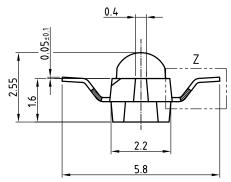
Conditions: T_{amb} < 30 °C, RH < 60 %

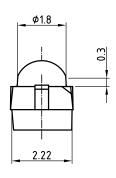
Moisture sensitivity level 2a, acc. to J-STD-020.

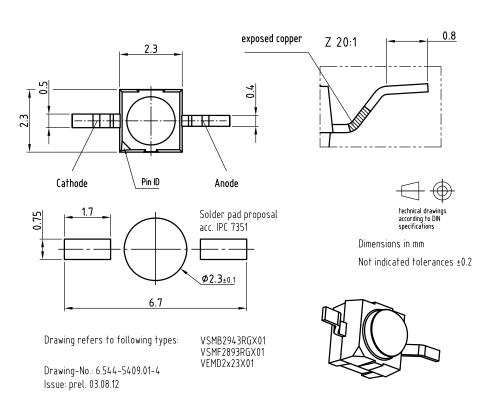
DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 $^{\circ}$ C (+ 5 $^{\circ}$ C), RH < 5 $^{\circ}$ M.

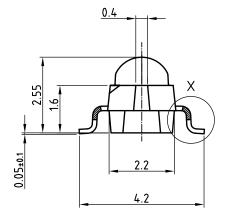
PACKAGE DIMENSIONS in millimeters: VSMB2948RG

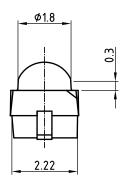


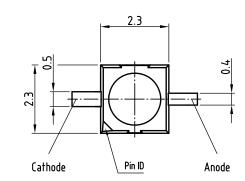


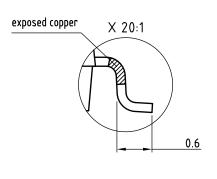


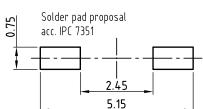
PACKAGE DIMENSIONS in millimeters: VSMB2948G













Not indicated tolerances ±0.2

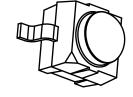
Drawing refers to following types:

VSMB2943GX01

VSMF2893GX01 VEMD2x23X01

Drawing-No.: 6.544-5408.01-4

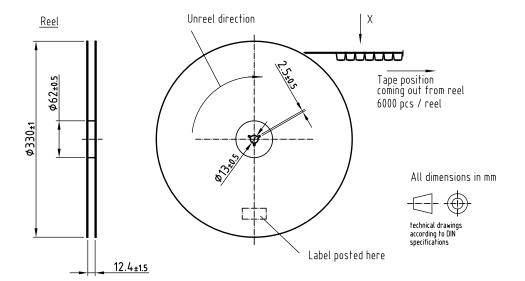
Issue: prel; 03.08.12



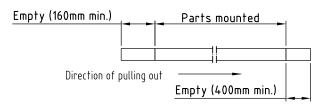
Dimensions in mm



TAPING AND REEL DIMENSIONS in millimeters: VSMB2848RG

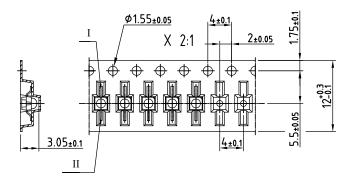


Leader and trailer tape:



Terminal position in tape

Device	Lead I	Lead II	
VSMB2943RGX01			
VSMF2893RGX01	C-11-4-	Anode	
VEMD2x03X01	Cathode Anoc		
VEMT2x03X01	Collector	Emitter	
	CONSCION	riiirrei	
VSMY2853RG	Anode	Cathode	



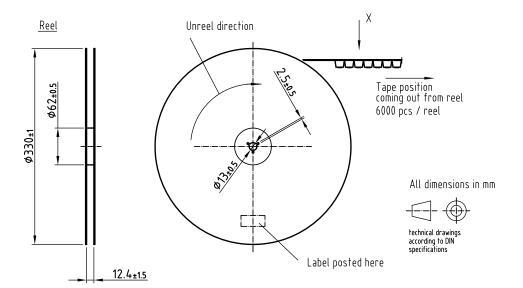
Drawing refers to following types: Reel dimensions and tape

see table

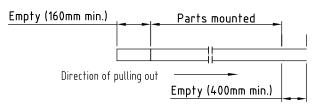
Drawing-No.: 9.800-5100.02-4 Issue: prel; 03.08.12



TAPING AND REEL DIMENSIONS in millimeters: VSMB2848G



Leader and trailer tape:



<u>Terminal p</u>	osition in	t <u>ape</u>	$\phi_{1.55\pm0.05}$ 4 ± 0.1	
Device	Lead I	Lead II	$\frac{I}{2\pm0.0}$ / X 2:1 $\frac{2\pm0.0}{2\pm0.0}$	
VSMB2943GX01			.\ /	
VSMF2893GX01	Cathode	Anode		
VEMD2x23X01		Carrioge	Alloue	
VEMT2x23X01	Collector	Emitter		
			205	
VSMY2853G	Anode	Cathode	$\frac{1}{2} = \frac{3.05 \pm 0.1}{3.05 \pm 0.1}$	
			П	

Drawing refers to following types: see table Reel dimensions and tape

Drawing-No.: 9.800-5091.21-4 Issue: prel; 03.08.12



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